



SSC8P22CN2

N-Channel Enhancement Mode MOSFET with PNP Transistor

➤ Features

N-Channel

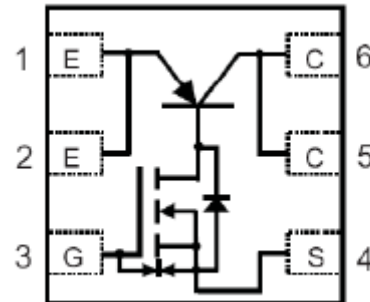
VDS	VGS	RDSON Typ.	ID
20V	±8V	255mR@4V5	0.8A
		390mR@2V5	

PNP Transistor

VCE	VBE	VCESAT Typ.	IC
-40V	-6V	-200mV	-3A

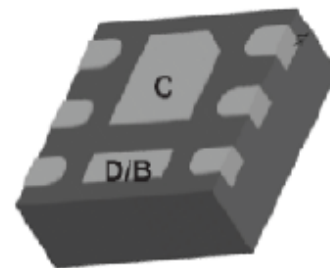
➤ Pin configuration

Top view



➤ Description

SSC8P22CN2 combines an N-Channel enhancement mode power MOSFET which is produced with high cell density and a Media Power PNP Transistor. The tiny and thin outline saves PCB consumption.



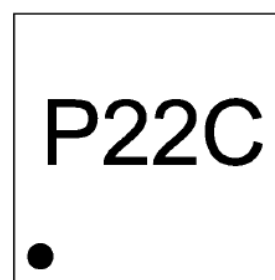
Bottom View

➤ Applications

- Li-Battery Charging
- Other power management in portable

➤ Ordering Information

Device	Package	Shipping
SSC8P22CN2	DFN2X2	3000/Reel



Marking

**SSC8P22CN2****➤ Absolute Maximum Ratings**($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
N-MOS			
V_{DSS}	Drain-to-Source Voltage	20	V
V_{GSS}	Gate-to-Source Voltage	± 8	V
I_{D}	Continuous Drain Current	0.8	A
I_{DM}	Pulsed Drain Current	3	A
PNP Transistor			
V_{CBO}	Collector-Base Voltage	-40	V
V_{CEO}	Collector-Emitter Voltage	-40	V
V_{EBO}	Emitter-Base Voltage	-6	V
I_{C}	Collector Current	-3	A
I_{CM}	Pulsed Collector Current	-6	A
Power Dissipation and Temperature			
P_{D}	Power Dissipation	2.6	W
T_{A}	Operation Temperature Range	-40 to 85	$^{\circ}\text{C}$
T_{L}	Lead Temperature	260	$^{\circ}\text{C}$
T_{J}	Operation junction temperature	-55 to 150	$^{\circ}\text{C}$
T_{STG}	Storage temperature range	-55 to 150	$^{\circ}\text{C}$

➤ Thermal Resistance Ratings($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit
$R_{\theta\text{JA}}$	Junction-to-Ambient Thermal Resistance	54	$^{\circ}\text{C/W}$



➤ **Electronics Characteristics**($T_A=25^{\circ}\text{C}$ unless otherwise noted)

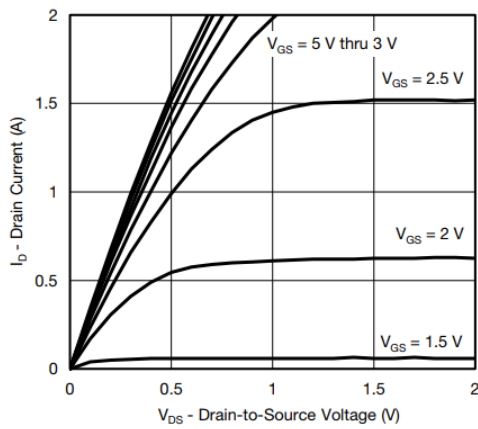
Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
N-Channel Enhancement Mode MOSFET						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=250\mu A$	20			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=250\mu A$	0.35	0.6	1	V
$R_{DS(on)}$	Drain-Source On- Resistance	$V_{GS}=4.5V$, $I_D=0.5A$		255	450	mR
		$V_{GS}=2.5V$, $I_D=0.5A$		390	765	
		$V_{GS}=1.8V$, $I_D=0.35A$		520	850	
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=16V$, $V_{GS}=0V$			1	μA
I_{GSS}	Gate-Source leak current	$V_{GS}=\pm 8V$, $V_{DS}=0V$			± 10	μA
V_{SD}	Forward Voltage	$V_{GS}=0V$, $I_S=0.1A$			1.3	V
G_{FS}	Transconductance	$V_{DS}=5V$, $I_D=0.5A$		2.2		S
C_{iss}	Input Capacitance	$V_{DS}=16V$, $V_{GS}=0V$, $f=200KHZ$		130		pF
C_{oss}	Output Capacitance			20		
C_{rss}	Reverse Transfer Capacitance			16		
$T_{D(ON)}$	Turn-on delay time	$V_{DS}=6V$, $V_{GS}=4.5V$, $R_L=6R$, $R_G=6R$, $I_D=0.8A$		6		ns
T_r	Turn-on rise time			24		
$T_{D(OFF)}$	Turn-off delay time			42		
T_f	Turn-off fall time			80		



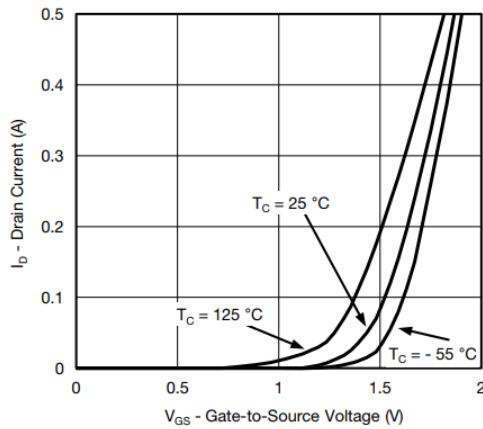
Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
PNP Transistor						
BVCBO	Collector-Base Breakdown Voltage	IC=-50uA IE=0	-40			V
BVCEO	Collector-Emitter Breakdown Voltage	IC=-1mA IB=0	-40			V
BVEBO	Emitter-Base Breakdown Voltage	IE=-50uA IC=0	-6			V
ICBO	Collector cut off current	VCB=-20V IE=0			-0.1	uA
IEBO	Emitter cut off current	VEB=-4V IC=0			-0.1	uA
HFE	DC Current Gain	VCE=-2V IC=-0.5A	100		350	
VCESAT	Collector-Emitter Saturation Voltage	IC=-0.8A IB=-80mA		-0.15	-0.2	V
VBESAT	Base-Emitter Saturation Voltage	IC=-0.8A IB=-80mA			-1.2	V
f _T	Transition frequency	VCE=-6V , IE=-0.02A f=30MHz	50	80		MHz



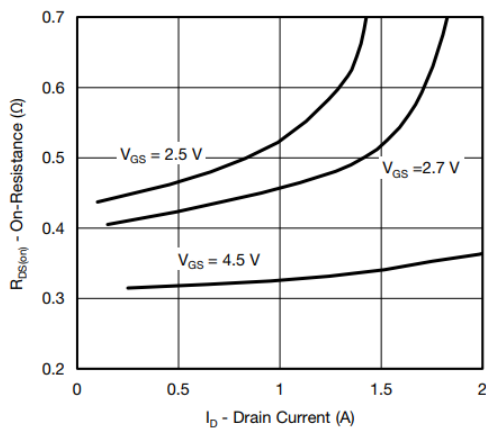
➤ **N-Channel Typical Characteristics**($T_A=25^\circ\text{C}$ unless otherwise noted)



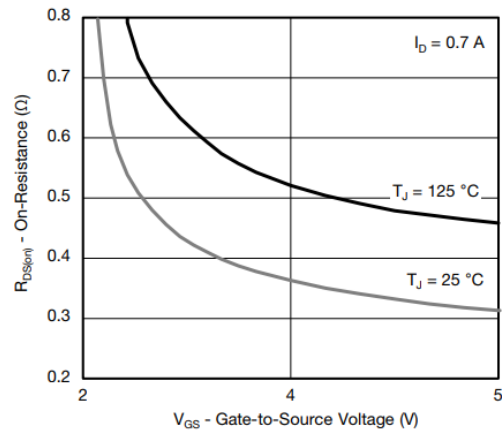
Output Characteristics



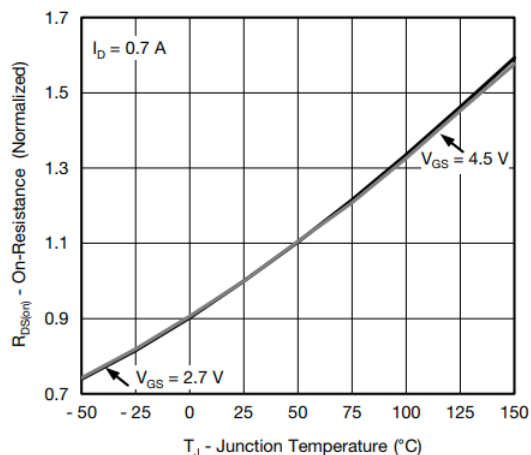
Transfer Characteristics



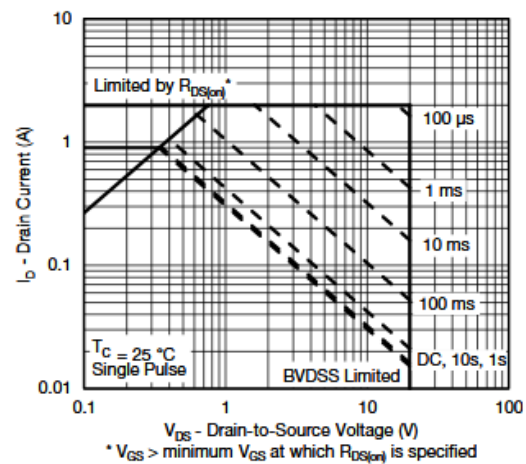
On-Resistance vs. Drain Current and Gate Voltage



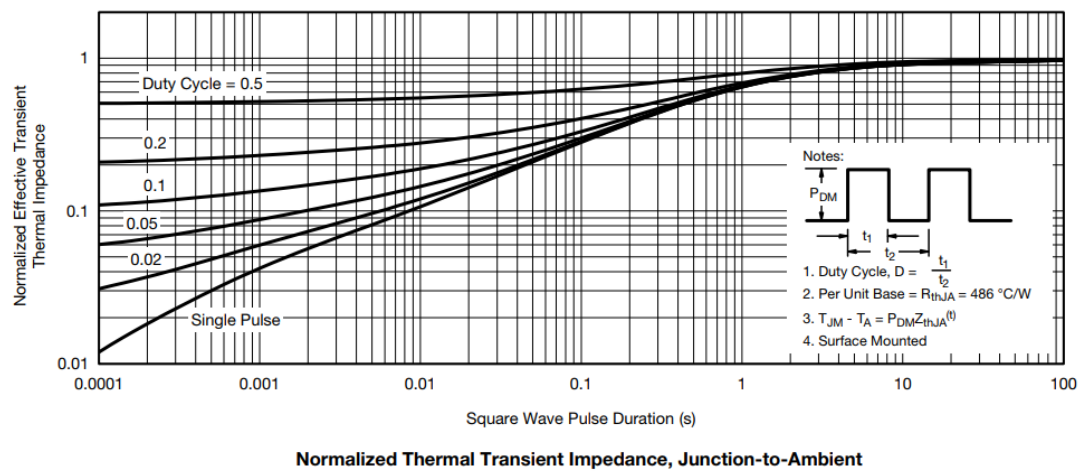
On-Resistance vs. Gate-to-Source Voltage



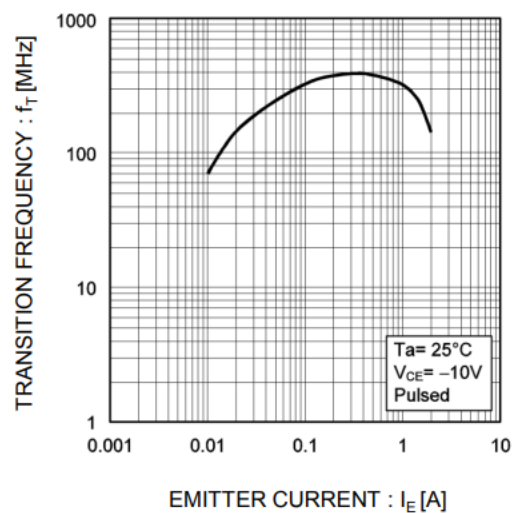
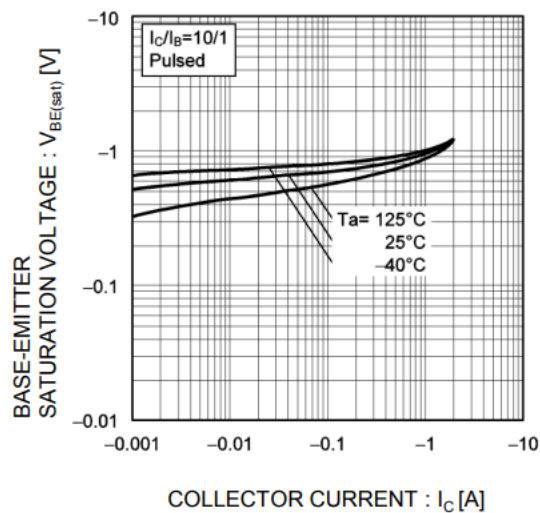
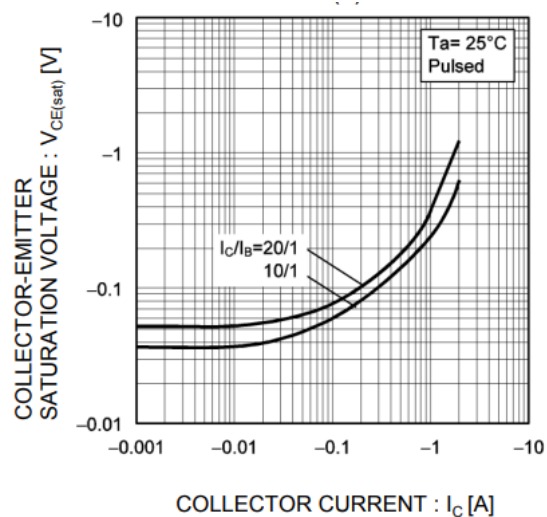
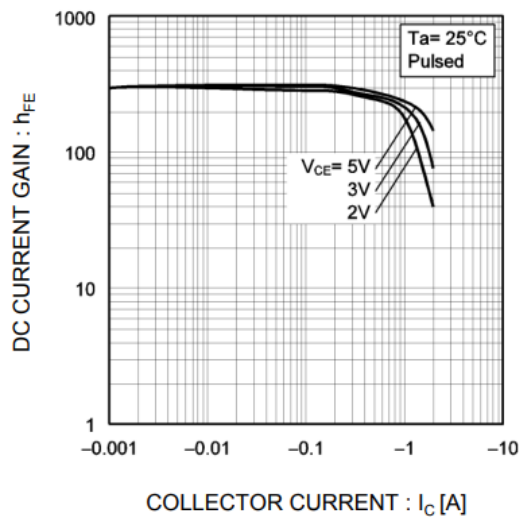
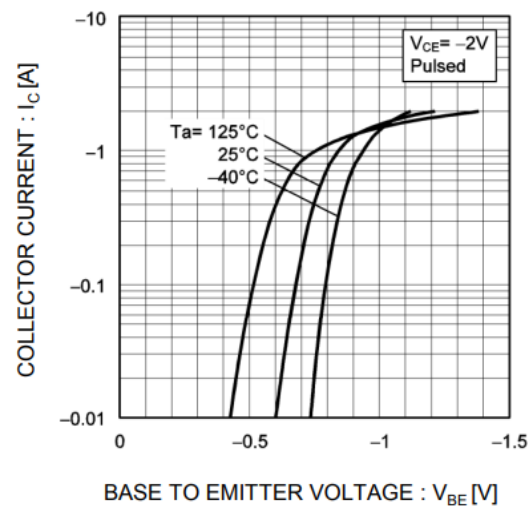
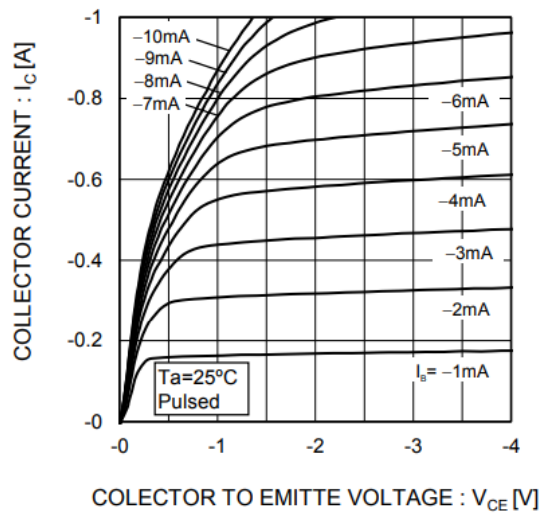
On-Resistance vs. Junction Temperature



Safe Operating Area, Junction-to-Ambient

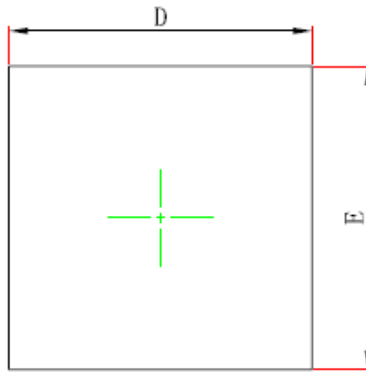


PNP Transistor Typical Performance Characteristics

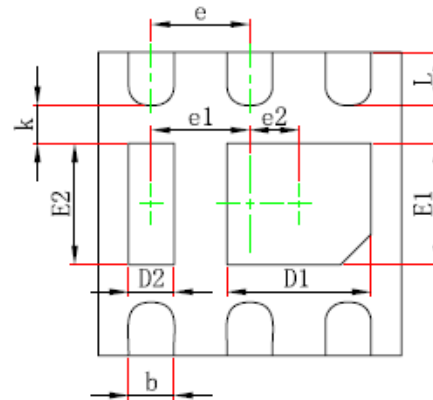




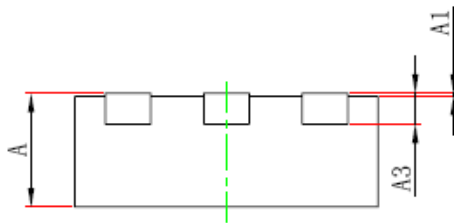
➤ Package Information



Top View



Bottom View



Side View

DFN2X2-6L

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700/0.800	0.800/0.900	0.028/0.032	0.032/0.035
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	1.924	2.076	0.076	0.082
E	1.924	2.076	0.076	0.082
D1	0.850	1.050	0.033	0.041
E1	0.700	0.900	0.028	0.035
D2	0.200	0.400	0.008	0.016
E2	0.700	0.900	0.028	0.035
e1	0.650TYP.		0.026TYP.	
e2	0.325TYP.		0.013TYP.	
k	0.200MIN.		0.008MIN.	
b	0.250	0.350	0.010	0.014
e	0.650TYP.		0.026TYP.	
L	0.300	0.400	0.012	0.016



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